

## **General Description**

The WSP4805 is the highest performance trench Dual P-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSP4805 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

## **Product Summery**

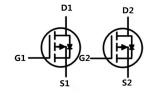
BVDSS	RDSON	ID
-30V	16mΩ	-8.0A

## **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

## **SOP-8 Pin Configuration**





## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-30	V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>c</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup>	-8.0	Α
I <sub>D</sub> @T <sub>c</sub> =70℃	Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup>	-7.1	Α
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	-40	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	49	mJ
I <sub>AS</sub>	Avalanche Current	-24	А
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation⁴	2.5	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	$^{\circ}$
TJ	Operating Junction Temperature Range -55 to 150		$^{\circ}$

### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>		90	°C/W
R <sub>eJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		20	°C/W



# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_D$ =-250uA	-30			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25℃, I <sub>D</sub> =-1mA		-0.022		V/°C
В	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V , I <sub>D</sub> =-8.0A		16	22	0
R <sub>DS(ON)</sub>		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-5.6A		18.5	28	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	\/ =\/     = 250A	-1.2	-1.4	-2.0	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=-250uA$		4.6		mV/℃
	Drain Source Loakage Current	V <sub>DS</sub> =-24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25℃			-1	uA
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =-24V , $V_{GS}$ =0V , $T_J$ =55 $^{\circ}$ C			-5	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20 V$ , $V_{DS}$ = $0 V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-3A		21.7		S
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		3.6	5.0	Ω
$Q_g$	Total Gate Charge (-4.5V)	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-8.9A		12		
$Q_{gs}$	Gate-Source Charge			5.9		nC
$Q_{gd}$	Gate-Drain Charge			4.7		
T <sub>d(on)</sub>	Turn-On Delay Time			8.9		
Tr	Rise Time	$V_{DD}$ =-15V , $V_{GS}$ =-10V , $R_G$ =6 $\Omega$ ,		10.8		
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =-1A, R <sub>L</sub> =15Ω,		35.5		- ns -
T <sub>f</sub>	Fall Time			46.9		
C <sub>iss</sub>	Input Capacitance			1025		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		209		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			158		

### **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy <sup>5</sup>	V <sub>DD</sub> =-25V , L=0.5mH , I <sub>AS</sub> =-24A	42			mJ

## **Diode Characteristics**

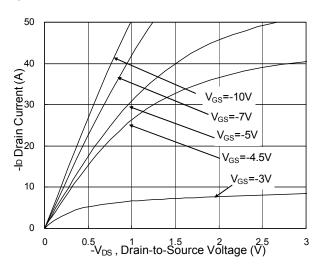
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I <sub>S</sub>	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-8	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>				-40	Α
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	$V_{GS}$ =0V , $I_{S}$ =-1A , $T_{J}$ =25 $^{\circ}$ C			-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	   IF=-8.9A,dI/dt=100A/μs,Tյ=25℃		16.5		nS
Q <sub>rr</sub>	Reverse Recovery Charge			6.2		nC

#### Note

- 1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =-25V,  $V_{GS}$ =-10V, L=0.5mH,  $I_{AS}$ =-24A
- 4.The power dissipation is limited by 150℃ junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



## **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

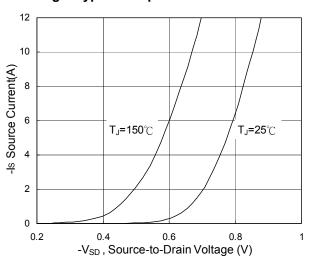


Fig.3 Forward Characteristics of Reverse

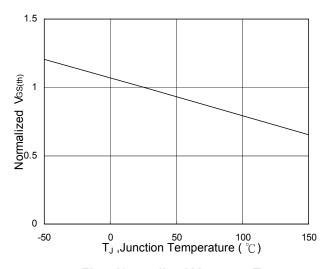


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

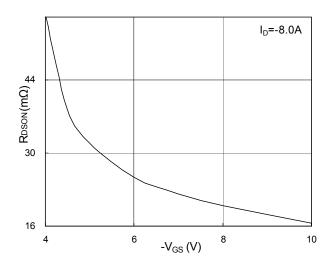


Fig.2 On-Resistance v.s Gate-Source

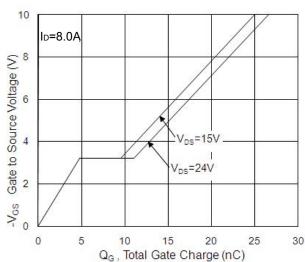


Fig.4 Gate-Charge Characteristics

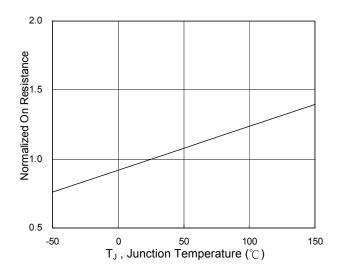
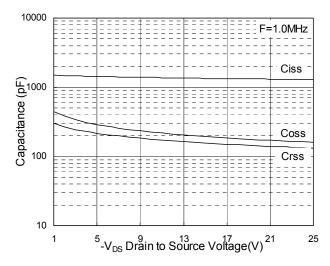


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>





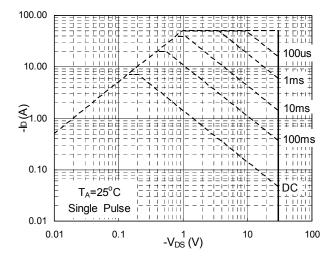


Fig.7 Capacitance

Fig.8 Safe Operating Area

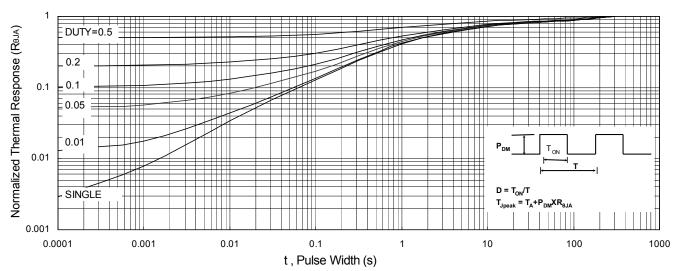


Fig.9 Normalized Maximum Transient Thermal Impedance

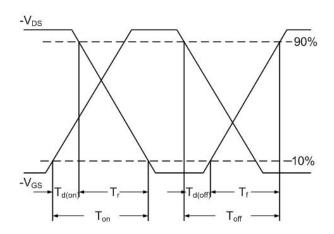


Fig.10 Switching Time Waveform

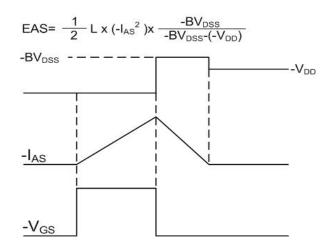


Fig.11 Unclamped Inductive Switching Waveform



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